

LM2902-Q1 QUADRUPLE OPERATIONAL AMPLIFIER

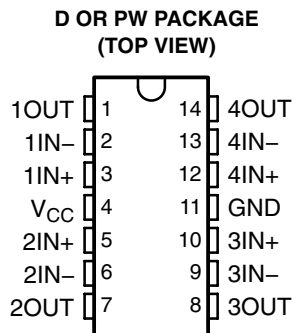
SGLS178E – AUGUST 2003 – REVISED APRIL 2008

- Qualified for Automotive Applications
- ESD Protection <500 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0); 1500 V Using Charged Device Model
- ESD Human Body Model >2 kV Machine Model >200 V and Charge Device Model = 2 kV For K-Suffix Devices.
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- Low Input Bias and Offset Parameters:
 - Input Offset Voltage . . . 3 mV Typ
 - Input Offset Current . . . 2 nA Typ
 - Input Bias Current . . . 20 nA Typ
- Common-Mode Input Voltage Range Includes Ground, Allowing Direct Sensing Near Ground
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage:
 - Non-V devices . . . 26 V
 - V-Suffix devices . . . 32 V
- Open-Loop Differential Voltage Amplification . . . 100 V/mV Typ
- Internal Frequency Compensation

description/ordering information

This device consists of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies is possible when the difference between the two supplies is 3 V to 26 V (3 V to 32 V for V-suffixed devices), and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

Applications include transducer amplifiers, dc amplification blocks, and all the conventional operational-amplifier circuits that now can be more easily implemented in single-supply-voltage systems. For example, the LM2902 can be operated directly from the standard 5-V supply that is used in digital systems and easily provides the required interface electronics without requiring additional ± 15 -V supplies.



ORDERING INFORMATION†

T_A	$V_{IO} \text{ max}$ AT 25°C	MAX V_{CC}	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	7 mV	26 V	SOIC (D)	Reel of 2500	LM2902QDRQ1	2902Q1
			TSSOP (PW)	Reel of 2000	LM2902QPWRQ1	2902Q1
	7 mV	32 V	SOIC (D)	Reel of 2500	LM2902KVQDRQ1	2902KVQ
			TSSOP (PW)	Reel of 2000	LM2902KVQPWRQ1	2902KVQ
	2 mV	32 V	SOIC (D)	Reel of 2500	LM2902KAVQDRQ1	2902KAQ
			TSSOP (PW)	Reel of 2000	LM2902KAVQPWRQ1	2902KAQ

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

‡ Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

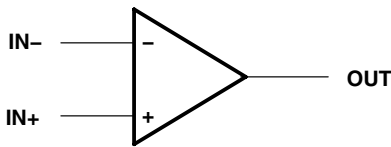
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2008 Texas Instruments Incorporated

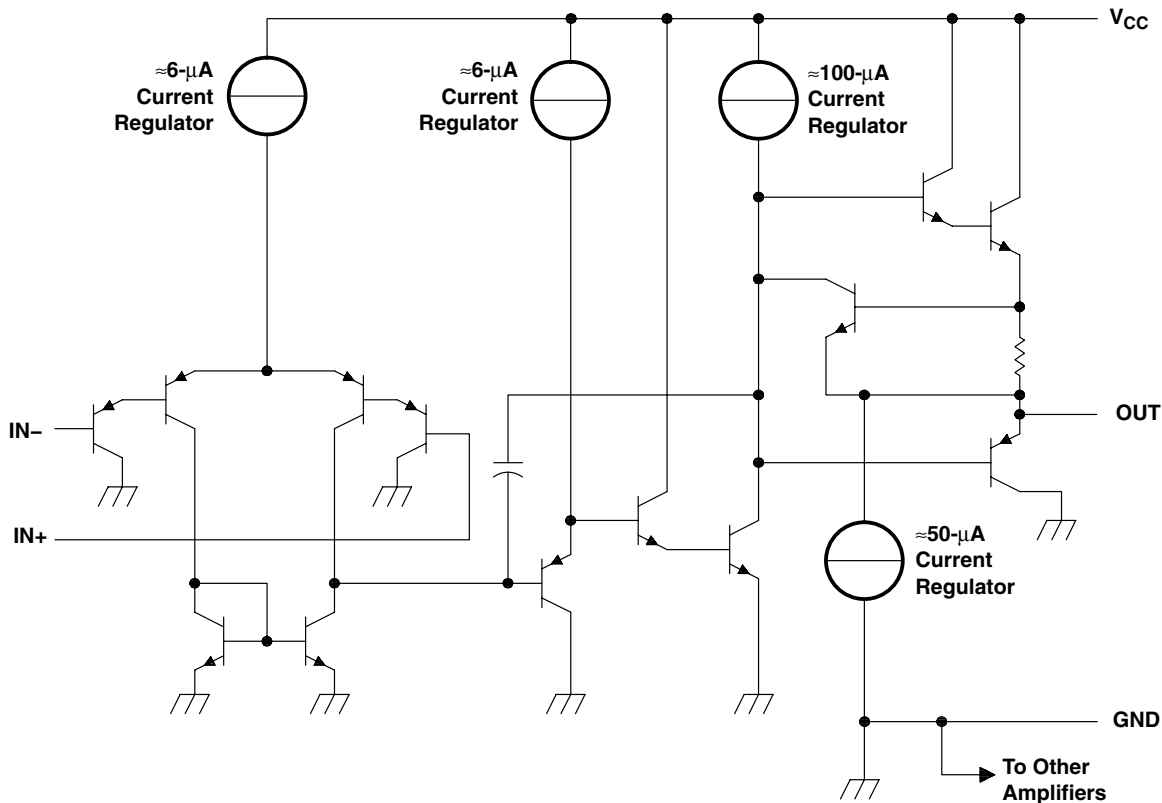
LM2902-Q1
QUADRUPLE OPERATIONAL AMPLIFIER

SGLS178E – AUGUST 2003 – REVISED APRIL 2008

symbol (each amplifier)



schematic (each amplifier)



COMPONENT COUNT (TOTAL DEVICE)	
Epi-FET	1
Transistors	95
Diodes	4
Resistors	11
Capacitors	4

LM2902-Q1

QUADRUPLE OPERATIONAL AMPLIFIER

SGLS178E – AUGUST 2003 – REVISED APRIL 2008

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

	LM2902-Q1	LM2902KV-Q1	UNIT
Supply voltage, V_{CC} (see Note 1)	26	32	V
Differential input voltage, V_{ID} (see Note 2)	± 26	± 32	V
Input voltage, V_I (either input)	-0.3 to 26	-0.3 to 32	V
Duration of output short circuit (one amplifier) to ground at (or below) $T_A = 25^\circ\text{C}$, $V_{CC} \leq 15\text{ V}$ (see Note 3)	Unlimited	Unlimited	
Package thermal impedance, θ_{JA} (see Notes 4 and 5)	D package (0 LFPM)	101	$^\circ\text{C/W}$
	PW package	113	
Operating virtual junction temperature, T_J	142	142	$^\circ\text{C}$
Storage temperature range, T_{stg}	-65 to 150	-65 to 150	$^\circ\text{C}$

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages and V_{CC} specified for the measurement of I_{OS} , are with respect to the network GND.
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
 4. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 142°C can affect reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.



LM2902-Q1

QUADRUPLE OPERATIONAL AMPLIFIER

SGLS178E – AUGUST 2003 – REVISED APRIL 2008

electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	T_A ‡	LM2902-Q1			UNIT
			MIN	TYP§	MAX	
V_{IO} Input offset voltage	$V_{CC} = 5\text{ V to } 26\text{ V}$, $V_{IC} = V_{ICRmin}$, $V_O = 1.4\text{ V}$	25°C		3	7	mV
		Full range			10	
I_{IO} Input offset current	$V_O = 1.4\text{ V}$	25°C		2	50	nA
		Full range			300	
I_{IB} Input bias current	$V_O = 1.4\text{ V}$	25°C		-20	-250	nA
		Full range			-500	
V_{ICR} Common-mode input voltage range	$V_{CC} = 5\text{ V to } 26\text{ V}$	25°C		0 to $V_{CC} - 1.5$		V
		Full range		0 to $V_{CC} - 2$		
V_{OH} High-level output voltage	$R_L = 10\text{ k}\Omega$	25°C		$V_{CC} - 1.5$		V
	$V_{CC} = 26\text{ V}$, $R_L = 2\text{ k}\Omega$	Full range		22		
	$V_{CC} = 26\text{ V}$, $R_L \geq 10\text{ k}\Omega$	Full range		23	24	
V_{OL} Low-level output voltage	$R_L \leq 10\text{ k}\Omega$	Full range		5	20	mV
A_{VD} Large-signal differential voltage amplification	$V_{CC} = 15\text{ V}$, $V_O = 1\text{ V to } 11\text{ V}$, $R_L \geq 2\text{ k}\Omega$	25°C		100		V/mV
		Full range		15		
CMRR Common-mode rejection ratio	$V_{IC} = V_{ICRmin}$	25°C		50	80	dB
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)		25°C		50	100	dB
V_{O1}/V_{O2} Crosstalk attenuation	$f = 1\text{ kHz to } 20\text{ kHz}$	25°C		120		dB
I_O Output current	$V_{CC} = 15\text{ V}$, $V_{ID} = 1\text{ V}$, $V_O = 0$	25°C		-20	-30 -60	mA
		Full range		-10		
	$V_{CC} = 15\text{ V}$, $V_{ID} = -1\text{ V}$, $V_O = 15\text{ V}$	25°C		10	20	
		Full range		5		
	$V_{ID} = -1\text{ V}$, $V_O = 200\text{ mV}$	25°C		30		μA
I_{OS} Short-circuit output current	V_{CC} at 5 V, $V_O = 0$, GND at -5 V	25°C		± 40	± 60	mA
I_{CC} Supply current (four amplifiers)	$V_O = 2.5\text{ V}$, No load	Full range		0.7	1.2	mA
	$V_{CC} = 26\text{ V}$, $V_O = 0.5 V_{CC}$, No load	Full range		1.4	3	

† All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.

‡ Full range is -40°C to 125°C.

§ All typical values are at $T_A = 25^\circ\text{C}$.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

LM2902-Q1

QUADRUPLE OPERATIONAL AMPLIFIER

SGLS178E – AUGUST 2003 – REVISED APRIL 2008

electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS†		T_A ‡	LM2902KV-Q1			UNIT
				MIN	TYP§	MAX	
V_{IO} Input offset voltage	$V_{CC} = 5\text{ V to } 32\text{ V}$, $V_{IC} = V_{ICRmin}$, $V_O = 1.4\text{ V}$	Non-A devices	25°C	3	7		mV
			Full range			10	
		A-suffix devices	25°C	1	2		
			Full range			4	
$\Delta V_{IO}/\Delta T$ Temperature drift	$R_S = 0\ \Omega$		Full range	7			$\mu\text{V}/^\circ\text{C}$
I_{IO} Input offset current	$V_O = 1.4\text{ V}$		25°C	2	50		nA
			Full range			150	
$\Delta I_{IO}/\Delta T$ Temperature drift			Full range	10			$\text{pA}/^\circ\text{C}$
I_{IB} Input bias current	$V_O = 1.4\text{ V}$		25°C	–20	–250		nA
			Full range			–500	
V_{ICR} Common-mode input voltage range	$V_{CC} = 5\text{ V to } 32\text{ V}$		25°C	0 to $V_{CC} - 1.5$			V
			Full range	0 to $V_{CC} - 2$			
V_{OH} High-level output voltage	$R_L = 10\text{ k}\Omega$		25°C	$V_{CC} - 1.5$			V
	$V_{CC} = 32\text{ V}$, $R_L = 2\text{ k}\Omega$		Full range	26			
	$V_{CC} = 32\text{ V}$, $R_L \geq 10\text{ k}\Omega$		Full range	27			
V_{OL} Low-level output voltage	$R_L \leq 10\text{ k}\Omega$		Full range	5	20		mV
A_{VD} Large-signal differential voltage amplification	$V_{CC} = 15\text{ V}$, $V_O = 1\text{ V to } 11\text{ V}$, $R_L \geq 2\text{ k}\Omega$		25°C	25	100		V/mV
			Full range	15			
Amplifier-to-amplifier coupling¶	$f = 1\text{ kHz to } 20\text{ kHz}$, input referred		25°C	120			dB
CMRR Common-mode rejection ratio	$V_{IC} = V_{ICRmin}$		25°C	60	80		dB
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)			25°C	60	100		dB
V_{O1}/V_{O2} Crosstalk attenuation	$f = 1\text{ kHz to } 20\text{ kHz}$		25°C	120			dB
I_O Output current	$V_{CC} = 15\text{ V}$, $V_O = 0$	$V_{ID} = 1\text{ V}$,	25°C	–20	–30	–60	mA
			Full range	–10			
	$V_{CC} = 15\text{ V}$, $V_O = 15\text{ V}$	$V_{ID} = -1\text{ V}$,	25°C	10	20		
			Full range	5			
	$V_{ID} = -1\text{ V}$, $V_O = 200\text{ mV}$		25°C	12	40		μA
I_{OS} Short-circuit output current	V_{CC} at 5 V, GND at –5 V	$V_O = 0$,	25°C	± 40	± 60		mA
I_{CC} Supply current (four amplifiers)	$V_O = 2.5\text{ V}$, No load		Full range	0.7	1.2		mA
	$V_{CC} = 32\text{ V}$, $V_O = 0.5 V_{CC}$, No load		Full range	1.4	3		

† All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.

‡ Full range is –40°C to 125°C.

§ All typical values are at $T_A = 25^\circ\text{C}$.

¶ Due to proximity of external components, ensure that coupling is not originating via stray capacitance between these external parts. Typically, this can be detected, as this type of coupling increases at higher frequencies.



LM2902-Q1

QUADRUPLE OPERATIONAL AMPLIFIER

SGLS178E – AUGUST 2003 – REVISED APRIL 2008

operating conditions, $V_{CC} = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
SR	Slew rate at unity gain	$R_L = 1\text{ M}\Omega$, $C_L = 30\text{ pF}$, $V_I = \pm 10\text{ V}$ (see Figure 1)	0.5	V/ μs
B_1	Unity-gain bandwidth	$R_L = 1\text{ M}\Omega$, $C_L = 20\text{ pF}$ (see Figure 1)	1.2	MHz
V_n	Equivalent input noise voltage	$R_S = 100\text{ }\Omega$, $V_I = 0\text{ V}$, $f = 1\text{ kHz}$ (see Figure 2)	35	nV/ $\sqrt{\text{Hz}}$

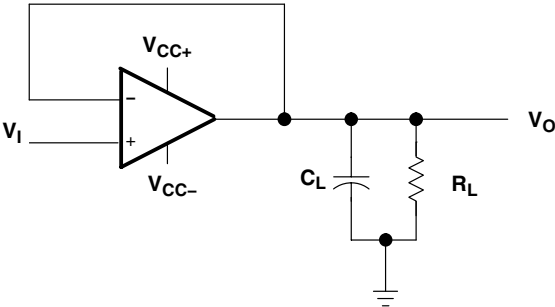


Figure 1. Unity-Gain Amplifier

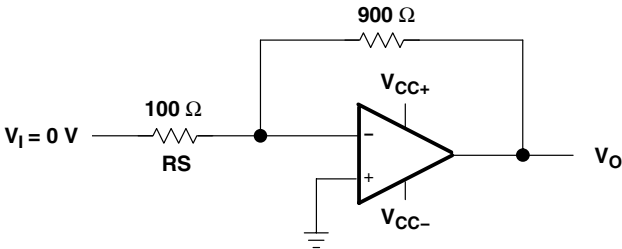


Figure 2. Noise-Test Circuit

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM2902KAVQDRG4Q1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KAQ	Samples
LM2902KAVQDRQ1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KAQ	Samples
LM2902KAVQPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KAQ	Samples
LM2902KAVQPWRQ1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KAQ	Samples
LM2902KVQDRG4Q1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KVQ	Samples
LM2902KVQDRQ1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KVQ	Samples
LM2902KVQPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KVQ	Samples
LM2902KVQPWRQ1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902KVQ	Samples
LM2902QDRG4Q1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902Q1	Samples
LM2902QDRQ1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902Q1	Samples
LM2902QPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902Q1	Samples
LM2902QPWRQ1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	2902Q1	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LM2902-Q1 :

- Catalog: [LM2902](#)
- Enhanced Product: [LM2902-EP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2902KAVQPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902KAVQPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902KVQPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902KVQPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902QPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2902QPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2902KAVQPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2902KAVQPWRQ1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2902KVQPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2902KVQPWRQ1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2902QPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2902QPWRQ1	TSSOP	PW	14	2000	367.0	367.0	35.0

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
 - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4211284-2/F 12/12

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com